

What is claimed is:

1. A manufacturing method for a display which uses an organic EL element in a display portion, involving respectively preparing a circuit substrate with microstructures made with drive circuits for said organic EL element set at positions corresponding to pixels, and with wiring formed on the surface, and a transparent substrate with a transparent electrode layer common with the pixels laminated on the surface, and an emissive layer containing the organic EL layer and a cathode layer laminated on the upper surface of the transparent electrode layer at a position corresponding to said pixels, and then sticking together said circuit substrate and said transparent substrate with the side on which said wiring of said circuit substrate is formed and the side on which said cathode layer of said transparent substrate is formed facing towards the inside.
2. The manufacturing method for an organic EL display according to claim 1, the sticking together of said circuit substrate and said transparent substrate being performed by inserting an anisotropic conductive paste or an anisotropic conductive film therebetween.
3. The manufacturing method for an organic EL display according to claim 1, involving respectively preparing a roll of said circuit substrate, and a roll of said transparent substrate, and then unrolling said circuit substrate and said transparent substrate from these rolls while inserting an anisotropic conductive film therebetween, and pressing with a pressing roller from front and rear surfaces to thereby stick together said circuit substrate and said transparent substrate.

4. The manufacturing method for an organic EL display according to claim 3, after sticking together said circuit substrate and said transparent substrate, the stuck together product being cut to an optional length.

5. An organic EL display which uses an organic EL element in a display portion, microstructures made with drive circuits for said organic EL element being set at positions corresponding to pixels of a first substrate, and an emissive layer containing an organic EL layer being formed on at least one of the first substrate and a second substrate, and these first substrate and second substrate being stuck together.

6. An organic EL display which uses an organic EL element in a display portion, a circuit substrate with microstructures made with drive circuits for the organic EL element set at positions corresponding to pixels, and with wiring formed on the surface, and a transparent substrate with a transparent electrode layer common with the pixels laminated on the surface, and an emissive layer containing the organic EL layer and a cathode layer laminated on the upper surface of said transparent electrode layer at a position corresponding to said pixels, being stuck together with the side on which said wiring of said circuit substrate is formed and the side on which said cathode layer of said transparent substrate is formed facing towards the inside.

7. The organic EL display according to claim 6, said circuit substrate and said transparent substrate being stuck together by inserting an anisotropic conductive paste or an anisotropic conductive film therebetween.

8. A manufacturing method for an electro-optic device which uses electro-optic elements in a display portion, involving respectively preparing a first substrate with microstructures formed with drive circuits for said electro-optic elements set at positions corresponding to pixels, and a second substrate with said electro-optic elements formed at positions corresponding to said pixels, and then sticking together said first substrate and said second substrate with the side of said first substrate on which said drive circuits are formed and the side of said second substrate on which said electro-optic elements are formed facing towards the inside.

9. An electro-optic device which uses electro-optic elements in a display portion, microstructures made with drive circuits for said electro-optic elements being set at positions corresponding to pixels of a first substrate, and an electro-optic layer being formed on at least one of said first substrate and a second substrate, and said first substrate and second substrate being stuck together.

10. An electronic device provided with the electro-optic device according to claim 9.